



# **Product Description**

- The 0805 SMD LED is much smaller, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- These LEDs have high reliability performance and are designed to work under a wide range of environmental conditions.
- Besides, lightweight makes them ideal for miniature applications. etc.

#### **Features**

- · Size(mm): 2.0\*1.25\*0.85mm
- · Compatible with automatic placement equipment
- · Moisture Sensitivity Level: 3
- · Color type: Yellow-green
- · Viewing Angle:120°
- · Pb-free
- · RoHS and REACH compliant

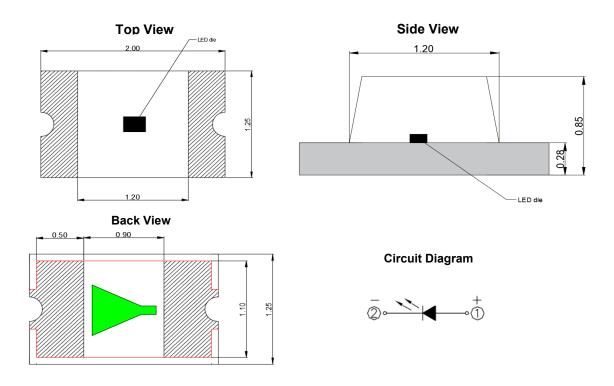
# **Applications**

- Backlighting in dashboard and switch.
- · Digital display for household appliace
- Telecommunication: indicator and backlighting in telephone and fax.
- · Flat backlight for LCD
- · General use



# **MECHANICAL DIMENSIONS**

All dimensions are in mm.



# Remark

The tolerance of all dimensions above is 0.1mm.



# ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C)

Items	Symbol	Absolute Maxium Rating	Unit
Forward current	l <sub>F</sub>	20	mA
Peak Forward Crurrent	I <sub>FP</sub>	60	mA
Reverse voltage	$V_{R}$	5	V
Power dissipation	$P_{D}$	40	mW
Operating temperature	$T_{opr}$	-40 ~+85	$^{\circ}$
Storage temperature	$T_{stg}$	-40~+100	${\mathbb C}$

Remark: 1/10 Duty cycle, 0.1ms pulse width.

# TYPICAL ELECTRICAL & OPTICAL CHARACTERISTICS ( $T_A = 25$ °C)

Charateristics	Symbol	Condition	Unit	Minimum	Typical
Forward Volatge	V <sub>F</sub>	I <sub>F</sub> =20mA	V		2.1
Reverse Current	$V_R$	V <sub>R</sub> =5V	uA		<1
Viewing Angle	2θ <sub>1/2</sub>	I <sub>F</sub> =20mA			120
Luminous intensity	I <sub>V</sub>	I <sub>F</sub> =20mA	mcd	28	
Spectral Line Half-Width	Δλ	I <sub>F</sub> =20mA	nm		20
Dominant Wavelength	λd	I <sub>F</sub> =20mA	nm	568	
Peak Wavelength	λр	I <sub>F</sub> =20mA	nm		574

<sup>\*</sup> Continuous reverse voltage can cause LED damage.



# **INTENSITY BIN LIMIT**

Yellow-green (20mA)			
Bin code	Min.(mcd)	Max.(mcd)	
JM1	28	34	
JM2	34	40	
JM3	40	48	
JM4	48	58	
JM5	58	70	
JM6	70	85	

<sup>\*</sup>Tolerance of measurement of luminous intensity is ±10%.

# **VOLTAGE BIN LIMIT**

Yellow-green (20mA)			
Bin code	Min.(V)	Max.(V)	
JV1	1.8	1.9	
JV2	1.9	2	
JV3	2	2.1	
JV4	2.1	2.2	
JV5	2.2	2.3	
JV6	2.3	2.4	

<sup>\*</sup>Tolerance of measurement of voltage is ±0.05V.

# **Color BIN LIMIT**

Yellow-green (20mA)			
Bin code	Min.(nm)	Max.(nm)	
JD1	568	570	
JD2	570	572	
JD3	572	574	
JD4	574	576	

<sup>\*</sup>Tolerance of measurement of wavelength is  $\pm 1 \text{nm}$ 

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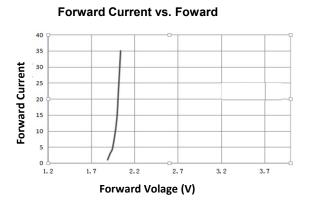
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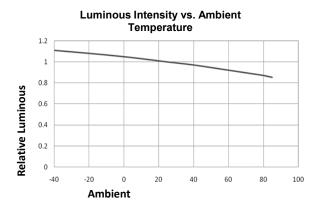


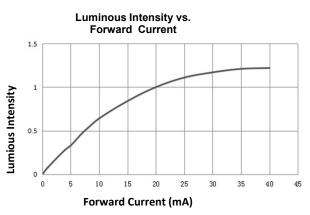
# TYPICAL ELECTRO-OPTICAL CHARATERISTICS CURES(Ta=25°C)

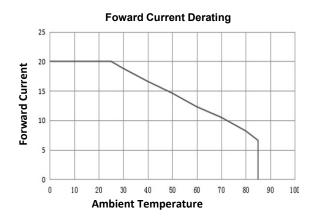
The data below are collected from statistical figures that do not necessarily correspond to the actual parameters of each single LED. Hence, these data will be changed without further notice.

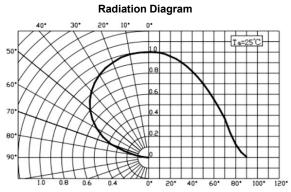
# Spectrum Distribution 1.2 1.2 1.2 0.8 0.6 0.4 0.2 0.380 430 480 530 580 630 680 730 780 Wavelength(nm)







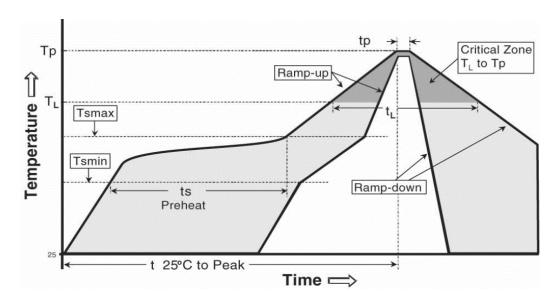






# **REFLOW SOLDERING**

- The CHIP LED is rated as a MSL3 as general request product.
- The recommended floor life out of bag is 24hrs.
- The temperature profile is as below.



#### IPC/JEDEC J-STD-020C

	0,32520 3 015 0200
Profile Feature	Pb-Free Assembly
Average ramp-up rate(Tsmax to Tp)	3°C/second max.
Preheat	
- Temperature Min(Ts <sub>min</sub> )	150℃
- Temperature Max(Ts <sub>max</sub> )	200℃
- Time(Tsmin to Ts <sub>max</sub> )	60-180 seconds
Time mainted above	
- Temperature(T <sub>L</sub> )	217℃
- Time(T <sub>L</sub> )	60-150 seconds
Peak Temperature(Tp)	260℃
Time within 5°C of actual peak Temperature(tp) <sup>2</sup>	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to peak Temperature	8 minutes max.



# **Moisture Sensitivity**

- · Beking recommends keeping CHIP LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain CHIP LEDs do not need special storage for moisture sensitivity.
- · Once the MBP is opened, CHIP LEDs may be stored as MSL 3 per IPC/JEDEC J-STD-020C, meaning they have one year of floor life in conditions of ≤ 30 °C/60% relative humidity (RH). Regardless of the storage condition, Beking LED recommends sealing any unsoldered CHIP LEDs in the original MBP.

#### Handling

- ·The packaging sizes of these SMD products are very small. Users are required to handle with care.
- ·To avoid damaging the product's surface and interior device, it is recommended to choose a

# Repairing

Repair should not be recommended after SMT production. When repairing is needed, a double-head soldering iron should be used (as below figure). It should be assured before handing whether the electrical and optical characteristics of the LEDs will or will not be damaged by



Fig.1 Pickig up a LED using an tweezer with care

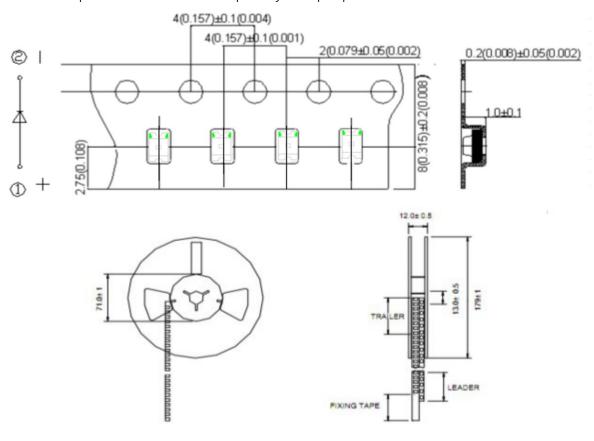


Fig2. Repairing using a doublehead soldering iron



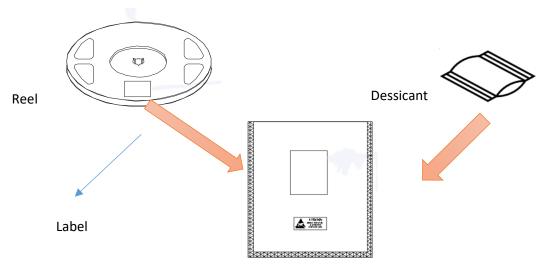
# **PACKING**

Carrier Tape Dimensions: Loaded quantity 3000pcs per reel.



#### All dimensions are in millimeters.

Tolerance of measurement of all dimensions is  $\pm 0.1$ mm



Polyethylene Bag